



FACTSHEET

Infineon Technologies (Kulim) Sdn Bhd

Managing Director : Mr Tan Soo Hee
Managing Director, Infineon Technologies (Kulim) Sdn Bhd

Site : Kulim operations

- Size of landplot 260,000 m² (26 hectares)
- Capacity of 100,000 Wafer Starts Per Month (WSPM) for 8 inch wafers
- 2 modules, each 5,000 m² Class 10 clean room with Class 1 Lithography

Employees : Targeted 1,700 employees at full capacity
(Approx. 70 percent direct functions; approx. 30 percent engineers and admin)

Investment : RM 3.8 billion (USD 1 billion)

Core Activities : Front-End Production

- Power and Logic Chips used in Industrial and Automotive sectors

Business Milestones

8 Dec 2004 Announcement of Infineon's expansion in Kulim High Tech Park

27 Jan 2005 Incorporation of Infineon Technologies (Kulim) Sdn Bhd

February 2005 Groundbreaking at Kulim High Tech Park

24 Aug 2005 Signing of Lease Agreement with Kulim Technology Park Corporation Bhd

February 2006 Equipment move-in and start of transfer

August 2006 Productive ramp-up

Office Address : **Infineon Technologies (Kulim) Sdn Bhd**
Lot 10 & 11
Industrial Zone Phase II
Kulim Hi-Tech Park
09000 Kulim
Kedah Darul Aman
Malaysia